

BUL1102EFP

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY INSULATED PACKAGE (U.L. COMPLIANT) FOR EASY MOUNTING

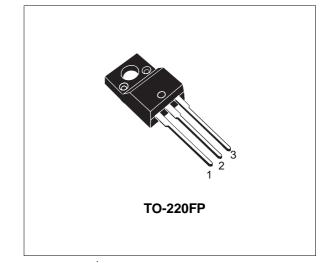
APPLICATIONS

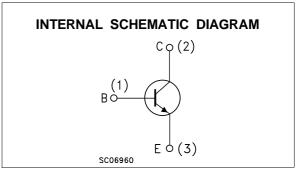
 FOUR LAMP ELECTRONIC BALLAST FOR: 120 V MAINS IN PUSH-PULL CONFIGURATION; 277 V MAINS IN HALF BRIDGE CURRENT FEED CONFIGURATION.

DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

Thanks to an increased intermediate layer, it has an intrinsic ruggedness which enables the transistor to withstand a high collector current level during Breakdown condition, without using the transil protection usually necessary in typical converters for lamp ballast.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
VCES	Collector-Emitter Voltage (V _{BE} = 0)	1100	V
V _{CEO}	Collector-Emitter Voltage $(I_B = 0)$	450	V
Vebo	Emitter-Base Voltage (I _C = 0)	12	V
Ic	Collector Current	4	Α
I _{CM}	Collector Peak Current (t _p <5 ms)	8	Α
Ι _Β	Base Current	2	Α
I _{BM}	Base Peak Current (t _p <5 ms)	4	Α
P _{tot}	Total Dissipation at $T_c = 25 \ ^{\circ}C$	30	W
Visol	Insulation Withstand Voltage (RMS) from All Three Leads to Exernal Heatsink	1500	
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

THERMAL DATA

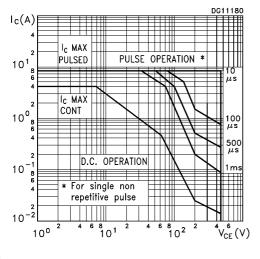
R _{thj-case}	Thermal Resistance Junction-Case	Max	4.17	°C/W	1

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \, {}^{\circ}C$ unless otherwise specified)

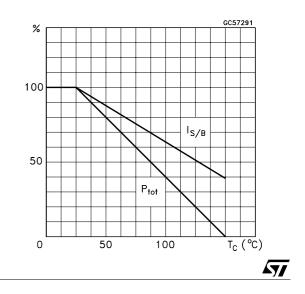
Symbol	Parameter	Test	Conditions	Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 1100 V				100	μA
I _{EBO}	Emitter Cut-off Current $(I_B = 0)$	V _{EB} = 12 V				1	mA
$V_{CEO(sus)^*}$	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 100 mA		450			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 2 A	I _B = 400 mA			1.5	V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 2 A	I _B = 400 mA			1.5	V
h _{FE} *	DC Current Gain	I _C = 250 mA I _C = 2 A	V _{CE} = 5 V V _{CE} = 5 V	40 12		70 23	
t _s t _f	RESISTIVE LOAD Storage Time Fall Time	I _C = 2.5 A I _{B1} = 0.5 A T _P = 30 μs				2.5 300	μs ns
Ear	Rpetitive Avalanche Energy	L = 2 mH $I_{BR} \le 2.5A$ (see figure 1)	C = 1.8 nF 25°C < T _C <125°C	6			mJ

* Pulsed: Pulse duration = $300 \,\mu$ s, duty cycle 1.5 %

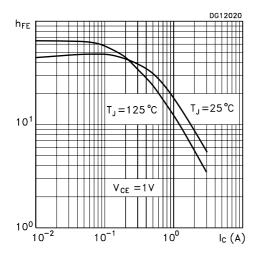
Safe Operating Areas



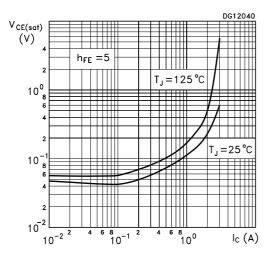
Derating Curve



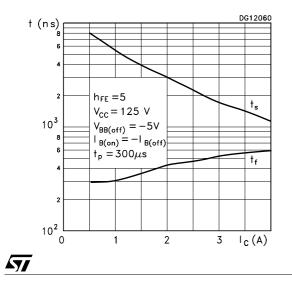
DC Current Gain



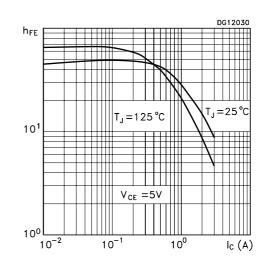
Collector Emitter Saturation Voltage

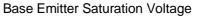


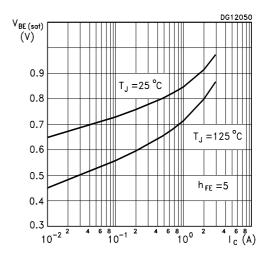
Switching Time Resistive Load

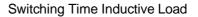


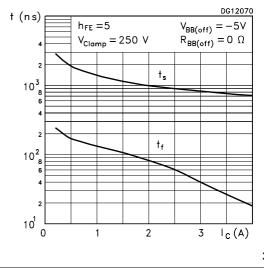
DC Current Gain











BUL1102EFP

Reverse Biased SOA

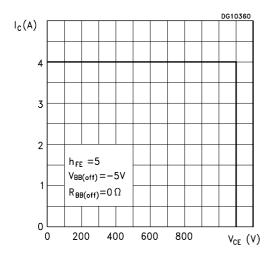


Figure 1: Energy Rating Test Circuit

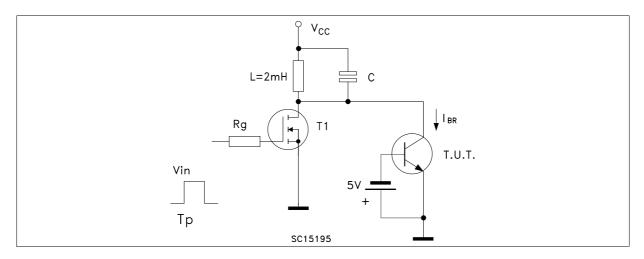
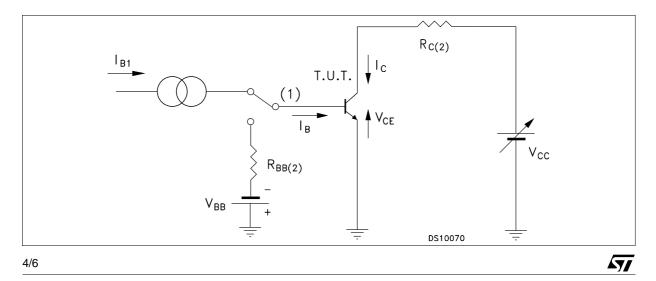
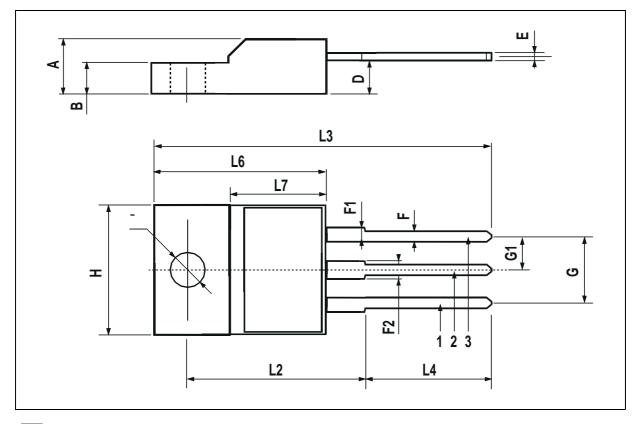


Figure 2: Resistive Load Switching Test Circuit



DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.4		4.6	0.173		0.181	
В	2.5		2.7	0.098		0.106	
D	2.5		2.75	0.098		0.108	
E	0.45		0.7	0.017		0.027	
F	0.75		1	0.030		0.039	
F1	1.15		1.7	0.045		0.067	
F2	1.15		1.7	0.045		0.067	
G	4.95		5.2	0.195		0.204	
G1	2.4		2.7	0.094		0.106	
Н	10		10.4	0.393		0.409	
L2		16			0.630		
L3	28.6		30.6	1.126		1.204	
L4	9.8		10.6	0.385		0.417	
L6	15.9		16.4	0.626		0.645	
L7	9		9.3	0.354		0.366	
Ø	3		3.2	0.118		0.126	

TO-220FP MECHANICAL DATA



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6/6

